

Shin-Etsu's platinum cure potting gels are ideal for stress reduction and vibration resistance for sensitive electronics components. They exhibit excellent unprimed adhesion to metals, plastics, glass and ceramics.

X-832-050 A/B

Penetration 70
1:1 Mix Ratio

5 minute snap time
Transparent

750cps mixed viscosity

X-832-299 A/B

Penetration 80
1:1 Mix Ratio

8 minute snap time
Transparent Purple

700cps mixed viscosity

KE-1051J A/B

Penetration 65
1:1 mix ratio

60 minute snap time
Optically clear

Resistant to yellowing
700cps mixed viscosity

SES22533-60

Shore 00 -60
1:1 mix ratio

9 minute snap time
Black

490cps mixed viscosity

SES22534-50

Shore 00 -60
1:1 mix ratio

30 minute snap time
Black

660cps mixed viscosity

